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Jameco Part Number 1757013



# OGY Programmable Quad Supply Monitor with Adjustable Reset Timer and Supply Tolerance

#### **FEATURES**

- Simultaneously Monitors Four Supplies
- 16 User Selectable Combinations of 5V, 3.3V, 3V, 2.5V, 1.8V, 1.5V and/or  $\pm$ Adjustable Voltage Thresholds
- Guaranteed Threshold Accuracy: ±1.5% of Monitored Voltage Over Temperature
- Selectable Supply Tolerance: 5%, 7.5%, 10%, 12.5% Below Monitored Voltage
- Low Supply Current: 43µA Typ
- Adjustable Reset Time
- RESET Disable Pin for Margining Applications
- Open-Drain RST Output (LTC2902-1)
- Push-Pull RST Output (LTC2902-2)
- Individual Nondelayed Monitor Outputs for Each Supply
- Power Supply Glitch Immunity
- Guaranteed RESET for V<sub>CC</sub> ≥ 1V

#### **APPLICATIONS**

- Desktop and Notebook Computers
- Multivoltage Systems
- Telecom Equipment
- Portable Battery-Powered Equipment
- Network Servers

#### DESCRIPTION

The LTC®2902 is a programmable supply monitor for systems with up to four supply voltages. One of 16 preset or adjustable voltage monitor combinations can be selected using an external resistor divider connected to the program pin. The preset voltage thresholds are digitally programmable to 5%, 7.5%, 10% or 12.5% below the nominal operating voltage, and are accurate to 1.5% over temperature. All four voltage comparator outputs are connected to separate pins for individual supply monitoring.

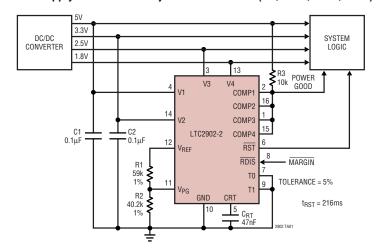
The reset delay time is adjustable using an external capacitor. Tight voltage threshold accuracy and glitch immunity ensure reliable reset operation without false triggering. The  $\overline{RST}$  output is guaranteed to be in the correct state for  $V_{CC}$  down to 1V and may be disabled during supply margin testing. The LTC2902-1 features an open-drain  $\overline{RST}$  output, while the LTC2902-2 has a push-pull  $\overline{RST}$  output.

The 43µA supply current makes the LTC2902 ideal for power conscious systems and the part may be configured to monitor less than four inputs. The LTC2902-1/LTC2902-2 are available in the 16-lead narrow SSOP package.

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# TYPICAL APPLICATION

Quad Supply Monitor with Adjustable Tolerance (5V, 3.3V, 2.5V, 1.8V)



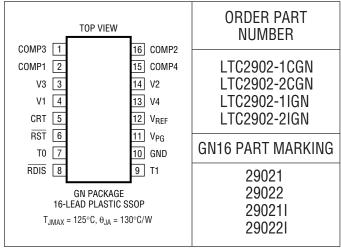


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# **ABSOLUTE MAXIMUM RATINGS**

(Notes 1, 2, 3)	
V1, V2, V3, V4, V <sub>PG</sub>	0.3V to 7V
RST (LTC2902-1)	0.3V to 7V
RST (LTC2902-2)	
COMPX, RDIS	
T0, T1	$-0.3V$ to $(V_{CC} + 0.3V)$
CRT	$-0.3V$ to $(V_{CC} + 0.3V)$
V <sub>REF</sub>	$-0.3V$ to $(V_{CC} + 0.3V)$
Reference Load Current (I <sub>VREF</sub> )	±1mÅ
V4 Input Current (-ADJ Mode)	–1mA
Operating Temperature Range	
LTC2902-1C/LTC2902-2C	0°C to 70°C
LTC2902-11/LTC2902-21	40°C to 85°C
Storage Temperature Range	65°C to 150°C
Lead Temperature (Soldering, 1	0 sec)300°C

# PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

# **ELECTRICAL CHARACTERISTICS**

**ELECTRICAL CHARACTERISTICS** The  $\bullet$  denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^{\circ}C$ .  $V_{CC} = 5V$ , unless otherwise noted. (Note 3)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V <sub>RT50</sub>	5V, 5% Reset Threshold 5V, 7.5% Reset Threshold 5V, 10% Reset Threshold 5V, 12.5% Reset Threshold	V1 Input Threshold	•	4.600 4.475 4.350 4.225	4.675 4.550 4.425 4.300	4.750 4.625 4.500 4.375	V V V
V <sub>RT33</sub>	3.3V, 5% Reset Threshold 3.3V, 7.5% Reset Threshold 3.3V, 10% Reset Threshold 3.3V, 12.5% Reset Threshold	V1, V2 Input Threshold	•	3.036 2.954 2.871 2.789	3.086 3.003 2.921 2.838	3.135 3.053 2.970 2.888	V V V
V <sub>RT30</sub>	3V, 5% Reset Threshold 3V, 7.5% Reset Threshold 3V, 10% Reset Threshold 3V, 12.5% Reset Threshold	V2 Input Threshold	•	2.760 2.685 2.610 2.535	2.805 2.730 2.655 2.580	2.850 2.775 2.700 2.625	V V V
V <sub>RT25</sub>	2.5V, 5% Reset Threshold 2.5V, 7.5% Reset Threshold 2.5V, 10% Reset Threshold 2.5V, 12.5% Reset Threshold	V2, V3 Input Threshold	•	2.300 2.238 2.175 2.113	2.338 2.275 2.213 2.150	2.375 2.313 2.250 2.188	V V V
V <sub>RT18</sub>	1.8V, 5% Reset Threshold 1.8V, 7.5% Reset Threshold 1.8V, 10% Reset Threshold 1.8V, 12.5% Reset Threshold	V3, V4 Input Threshold	•	1.656 1.611 1.566 1.521	1.683 1.638 1.593 1.548	1.710 1.665 1.620 1.575	V V V
V <sub>RT15</sub>	1.5V, 5% Reset Threshold 1.5V, 7.5% Reset Threshold 1.5V, 10% Reset Threshold 1.5V, 12.5% Reset Threshold	V3, V4 Input Threshold	•	1.380 1.343 1.305 1.268	1.403 1.365 1.328 1.290	1.425 1.388 1.350 1.313	V V V
V <sub>RTA</sub>	ADJ, 5% Reset Threshold ADJ, 7.5% Reset Threshold ADJ, 10% Reset Threshold ADJ, 12.5% Reset Threshold	V3, V4 Input Threshold	•	0.492 0.479 0.466 0.453	0.500 0.487 0.473 0.460	0.508 0.494 0.481 0.467	V V V

# **ELECTRICAL CHARACTERISTICS**

The  $\bullet$  denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^{\circ}C$ .  $V_{CC} = 5V$ , unless otherwise noted. (Note 3)

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
$\overline{V_{RTAN}}$	-ADJ Reset Threshold	V4 Input Threshold	•	-18	0	18	mV
V <sub>CC</sub>	Minimum Internal Operating Voltage	RST, COMPX in Correct Logic State; V <sub>CC</sub> Rising Prior to Program	•			1	V
V <sub>CCMINP</sub>	Minimum Required for Programming	V <sub>CC</sub> Rising	•			2.42	V
V <sub>CCMINC</sub>	Minimum Required for Comparators	V <sub>CC</sub> Falling	•			2.32	V
V <sub>REF</sub>	Reference Voltage	$\label{eq:VCC} \begin{split} V_{CC} &\geq 2.3V, \ I_{VREF} = \pm 1 mA, \ C_{REF} \leq 1000 pF \\ & \text{T0 Low, T1 Low} \\ & \text{T0 Low, T1 High} \\ & \text{T0 High, T1 Low} \\ & \text{T0 High, T1 High} \end{split}$	•	1.192 1.160 1.128 1.096	1.210 1.178 1.146 1.113	1.228 1.195 1.163 1.130	V V V
$V_{PG}$	Programming Voltage Range	$V_{CC} \ge V_{CCMINP}$	•	0		$V_{REF}$	V
$I_{VPG}$	V <sub>PG</sub> Input Current	$V_{PG} = V_{REF}$	•			±20	nA
I <sub>V1</sub>	V1 Input Current	$V1 = 5V$ , $I_{VREF} = 12\mu A$ , (Note 4)	•		43	75	μΑ
$I_{V2}$	V2 Input Current	V2 = 3.3V	•		0.8	2	μΑ
I <sub>V3</sub>	V3 Input Current	V3 = 2.5V V3 = 0.55V (ADJ Mode)	•	-15	0.52	1.2 15	μA nA
I <sub>V4</sub>	V4 Input Current	V4 = 1.8V V4 = 0.55V (ADJ Mode) V4 = -0.05V (-ADJ Mode)	•	-15 -15	0.34	0.8 15 15	μA nA nA
I <sub>CRT(UP)</sub>	CRT Pull-Up Current	V <sub>CRT</sub> = 0V	•	-1.4	-2	-2.6	μА
I <sub>CRT(DN)</sub>	CRT Pull-Down Current	V <sub>CRT</sub> = 1.3V	•	10	20	30	μА
t <sub>RST</sub>	Reset Time-Out Period	C <sub>RT</sub> = 1500pF	•	5	7	9	ms
t <sub>UV</sub>	V <sub>X</sub> Undervoltage Detect to RST or COMPX	$V_X$ Less Than Reset Threshold $V_{RTX}$ by More Than $1\%$			150		μS
$V_{OL}$	Output Voltage Low RST, COMPX	I <sub>SINK</sub> = 2.5mA; V1 = 3V, V2 = 3V; V3, V4 = 0V; V <sub>PG</sub> = 0V	•		0.15	0.4	V
		I <sub>SINK</sub> = 100μA; V2 = 1V; V1, V3, V4 = 0V I <sub>SINK</sub> = 100μA; V1 = 1V; V2, V3, V4 = 0V	•		0.05 0.05	0.3 0.3	V
V <sub>OH</sub>	Output Voltage High RST, COMPX (Note 5)	I <sub>SOURCE</sub> = 1μA	•	V2 – 1			V
V <sub>OH</sub>	Output Voltage High RST (LTC2902-2) (Note 6)	I <sub>SOURCE</sub> = 200μA	•	0.8 • V2			V
Digital Inpu	uts TO, T1, RDIS						
V <sub>IL</sub>	T0, T1 Low Level Input Voltage	V <sub>CC</sub> = 3.3V to 5.5V	•			0.3V <sub>CC</sub>	V
V <sub>IH</sub>	T0, T1 High Level Input Voltage	V <sub>CC</sub> = 3.3V to 5.5V	•	0.7V <sub>CC</sub>			V
I <sub>INTOL</sub>	T0, T1 Input Current	T0 = 0V, T1 = V <sub>CC</sub>	•		±0.1	±1	μА
$V_{IL}$	RDIS Input Threshold Low	V <sub>CC</sub> = 3.3V to 5.5V	•	0.4			V
$V_{IH}$	RDIS Input Threshold High	V <sub>CC</sub> = 3.3V to 5.5V	•			1.6	V
I <sub>RDIS</sub>	RDIS Pull-Up Current	V <sub>RDIS</sub> = 0V			-10		μА

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: All voltage values are with respect to GND.

**Note 3:** The greater of V1, V2 is the internal supply voltage  $(V_{CC})$ .

Note 4: Under static no-fault conditions, V1 will necessarily supply quiescent current. If at any time V2 is larger than V1, V2 must be capable of supplying the quiescent current, programming (transient) current and reference load current.

Note 5: The output pins RST and COMPX have internal pull-ups to V2 of typically 6µA. However, external pull-up resistors may be used when faster rise times are required or for V<sub>OH</sub> voltages greater than V2.

Note 6: The push-pull RST output pin on the LTC2902-2 is actively pulled up to V2.



# **TEST CIRCUITS**

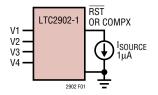


Figure 1. RST, COMPX V<sub>OH</sub> Test

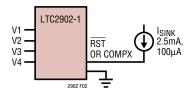


Figure 2.  $\overline{RST}$ , COMPX V<sub>OL</sub> Test

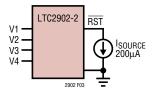
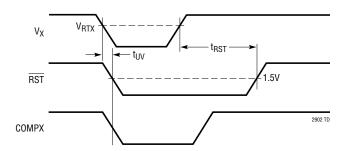


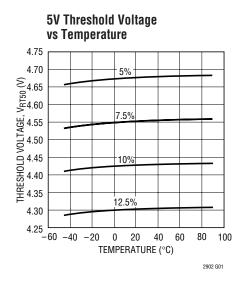
Figure 3. Active Pull-Up RST V<sub>OH</sub> Test

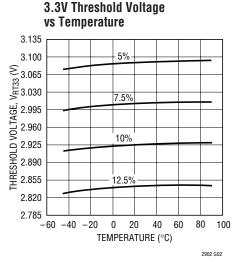
# TIMING DIAGRAM

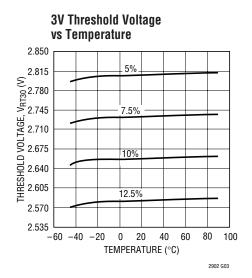
#### **V<sub>X</sub>** Monitor Timing



# TYPICAL PERFORMANCE CHARACTERISTICS



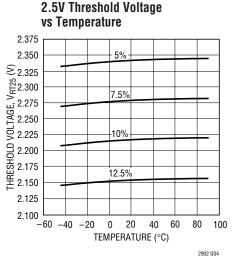


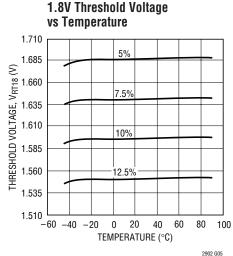


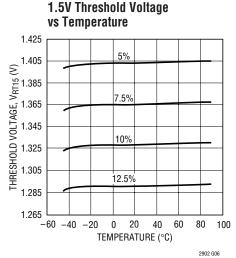
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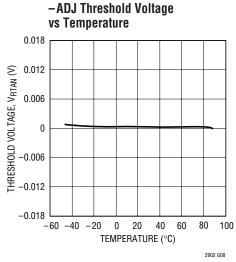
# TYPICAL PERFORMANCE CHARACTERISTICS

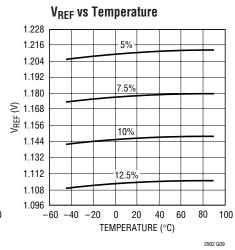


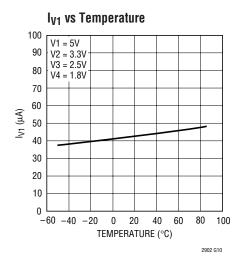


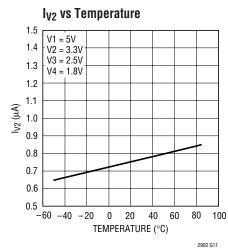


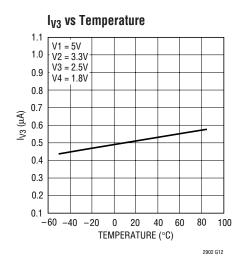
#### **ADJ Threshold Voltage** vs Temperature 0.508 0.503 € 0.498 ¥ 0.493 0.488 0.483 0.478 7.5% O.478 0.473 0.468 0.463 10% 12.5% 0.458 0.453 -60 -40 -20 0 20 40 60 80 100 TEMPERATURE (°C)





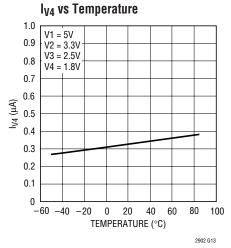


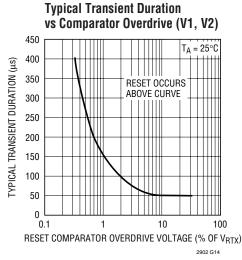


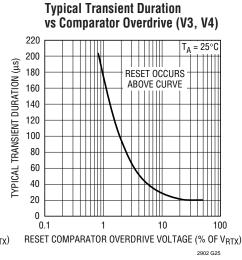


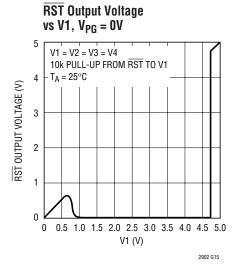


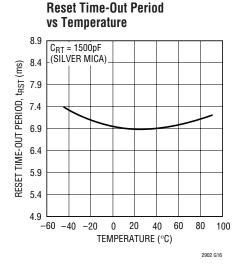
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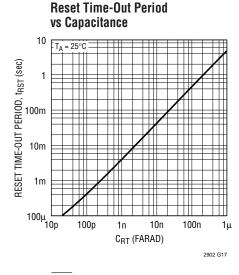


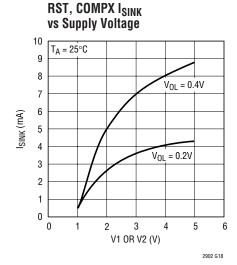


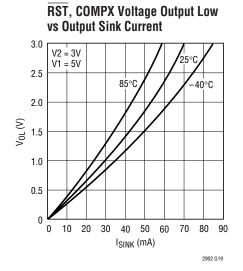


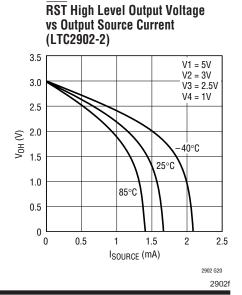






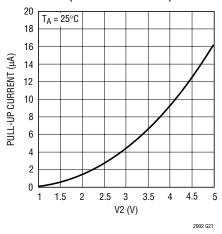


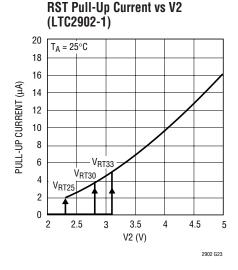




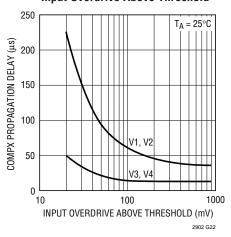
#### TYPICAL PERFORMANCE CHARACTERISTICS

COMPX Pull-Up Current vs V2 (COMPX Held at OV)

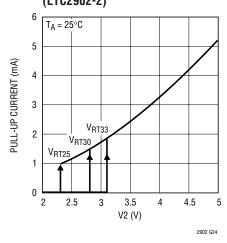




COMPX Propagation Delay vs Input Overdrive Above Threshold



RST Pull-Up Current vs V2 (LTC2902-2)



# PIN FUNCTIONS

**COMP3 (Pin 1):** Comparator Output 3. Nondelayed, active high logic output with weak pull-up to V2. Pulls high when V3 is above reset threshold. May be pulled greater than V2 using external pull-up.

**COMP1 (Pin 2):** Comparator Output 1. Nondelayed, active high logic output with weak pull-up to V2. Pulls high when V1 is above reset threshold. May be pulled greater than V2 using external pull-up.

V3 (Pin 3): Voltage Input 3. Select from 2.5V, 1.8V, 1.5V or ADJ. See Table 1 for details.

**V1 (Pin 4):** Voltage Input 1. Select from 5V or 3.3V. See Table 1 for details. The greater of (V1, V2) is also  $V_{CC}$  for the chip. Bypass this pin to ground with a  $0.1\mu F$  (or greater) capacitor.

**CRT (Pin 5):** Reset Delay Time Programming Pin. Attach an external capacitor ( $C_{RT}$ ) to GND to set a reset delay time of 4.6ms/nF. Leaving the pin open generates a minimum delay of approximately 50 $\mu$ s. A 47nF capacitor will generate a 216ms reset delay time.



# PIN FUNCTIONS

**RST (Pin 6):** Reset Logic Output. Active low with weak pull-up to V2 (LTC2902-1) or active pull-up to V2 (LTC2902-2). Pulls low when any voltage input is below the reset threshold and held low for programmed delay time after all voltage inputs are above threshold. May be pulled above V2 using an external pull-up (LTC2902-1 only).

**TO (Pin 7):** Digital Input for Supply Tolerance Selection (5%, 7.5%, 10% or 12.5%). Used in conjunction with T1 (Pin 9). See Applications Information for tolerance selection chart (Table 4).

RDIS (Pin 8): Digital Input for RST Disable. A low input on this pin forces the RST output to V2 (or pull-up voltage). Useful for determining supply margins without issuing reset command to processor. A weak internal pull-up allows pin to be left floating for normal monitor operation.

**T1 (Pin 9):** Digital Input for Supply Tolerance Selection (5%, 7.5%, 10% or 12.5%). Used in conjunction with T0 (Pin 7). See Applications Information for tolerance selection chart (Table 4).

GND (Pin 10): Ground.

 $V_{PG}$  (Pin 11): Voltage Threshold Combination Select Input. Connect to an external 1% resistive divider between  $V_{REF}$  and GND to select 1 of 16 combinations of preset and/or $\pm$ adjustable voltage thresholds (see Table 1). Do not add capacitance on the  $V_{PG}$  pin.

 $V_{REF}$  (Pin 12): Buffered Reference Voltage. A 1.210V nominal reference used for programming voltage ( $V_{PG}$ ) and for the offset of negative adjustable applications. The buffered reference can source and sink up to 1mA. The reference can drive a bypass capacitor of up to 1000pF without oscillation.

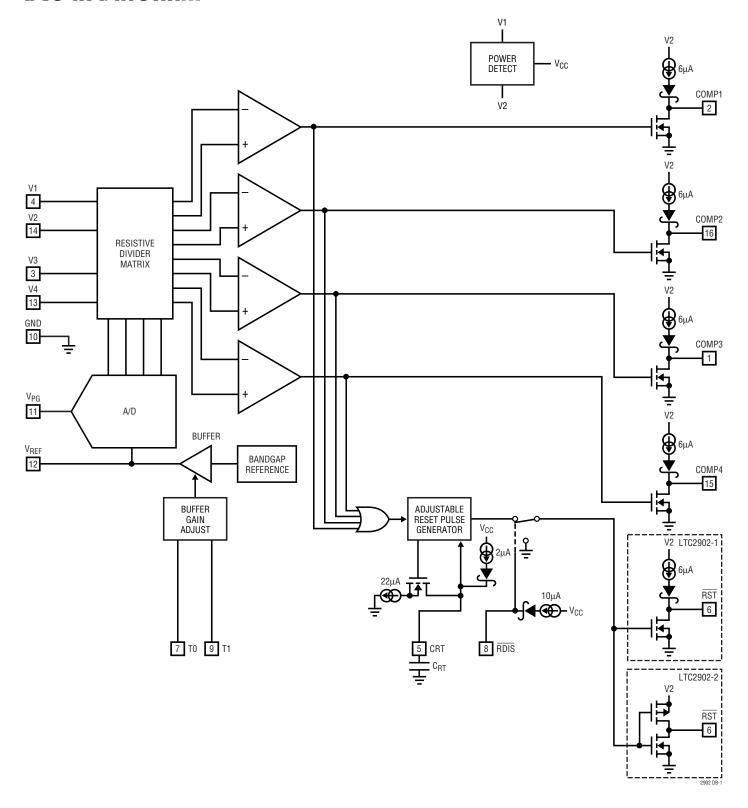
**V4 (Pin 13):** Voltage Input 4. Select from 1.8V, 1.5V, ADJ or –ADJ. See Table 1 for details.

**V2 (Pin 14):** Voltage Input 2. Select from 3.3V, 3V or 2.5V. See Table 1 for details. The greater of (V1, V2) is also  $V_{CC}$  for chip. Bypass this pin to ground with a 0.1μF (or greater) capacitor. All logic outputs (COMP1, COMP2, COMP3, COMP4) are weakly pulled up to V2. RST is weakly pulled up to V2 in the LTC2902-1 and RST is actively pulled up to V2 in the LTC2902-2.

**COMP4 (Pin 15):** Comparator Output 4. Nondelayed, active high logic output with weak pull-up to V2. Pulls high when V4 is above reset threshold. May be pulled greater than V2 using external pull-up.

**COMP2** (**Pin 16**): Comparator Output 2. Nondelayed, active high logic output with weak pull-up to V2. Pulls high when V2 is above reset threshold. May be pulled greater than V2 using external pull-up.

# **BLOCK DIAGRAM**





#### APPLICATIONS INFORMATION

#### Power-Up

On power-up, the larger of V1 or V2 will power the drive circuits for the RST and the COMPX pins. This ensures that the RST and COMPX outputs will be low as soon as V1 or V2 reaches 1V. The RST and COMPX outputs will remain low until the part is programmed. After programming, if any one of the  $V_X$  inputs is below its programmed threshold, RST will be a logic low. Once all the  $V_X$  inputs rise above their thresholds, an internal timer is started and RST is released after the programmed delay time. If  $V_{CC} < (V3-1)$  and  $V_{CC} < 2.4V$ , the V3 input impedance will be low  $(1k\Omega$  typ).

#### **Monitor Programming**

The LTC2902 input voltage combination is selected by placing the recommended resistor divider from  $V_{REF}$  to GND and connecting the tap point to  $V_{PG}$ , as shown in Figure 4. Table 1 offers recommended 1% resistor values for the various modes. The last column in Table 1 specifies optimum  $V_{PG}/V_{REF}$  ratios ( $\pm 0.01$ ) to be used when programming with a ratiometric DAC.

During power-up, once V1 or V2 reaches 2.4V (max), the monitor enters a programming period of approximately  $150\mu s$  during which the voltage on the  $V_{PG}$  pin is sampled and the monitor is configured to the desired input combination. Do not add capacitance to the  $V_{PG}$  pin. Immediately after programming, the comparators are enabled and supply monitoring will begin.

#### **Supply Monitoring**

The LTC2902 is a low power, high accuracy programmable quad supply monitoring circuit with four nondelayed monitor outputs, a common reset output and selectable supply thresholds. Reset timing is adjustable using an external capacitor. Single pin programming selects 1 of 16 input voltage monitor combinations. Two digital inputs select one of four supply tolerances (5%, 7.5%, 10% or 12.5%). All four voltage inputs must be above predetermined thresholds for the reset not to be invoked. The LTC2902 will assert the reset and comparator outputs during power-up, power-down and brownout conditions on any one of the voltage inputs.

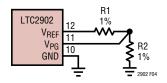


Figure 4. Monitor Programming

**Table 1. Voltage Threshold Programming** 

MODE	V1 (V)	V2 (V)	V3 (V)	V4 (V)	R1 (kΩ)	<b>R2</b> (kΩ)	V <sub>PG</sub> V <sub>REF</sub>
0	5.0	3.3	ADJ	ADJ	Open	Short	0.000
1	5.0	3.3	ADJ	-ADJ	93.1	9.53	0.094
2	3.3	2.5	ADJ	ADJ	86.6	16.2	0.156
3	3.3	2.5	ADJ	-ADJ	78.7	22.1	0.219
4	3.3	2.5	1.5	ADJ	71.5	28.0	0.281
5	5.0	3.3	2.5	ADJ	66.5	34.8	0.344
6	5.0	3.3	2.5	1.8	59.0	40.2	0.406
7	5.0	3.3	2.5	1.5	53.6	47.5	0.469
8	5.0	3.0	2.5	ADJ	47.5	53.6	0.531
9	5.0	3.0	ADJ	ADJ	40.2	59.0	0.594
10	3.3	2.5	1.8	1.5	34.8	66.5	0.656
11	3.3	2.5	1.8	ADJ	28.0	71.5	0.719
12	3.3	2.5	1.8	-ADJ	22.1	78.7	0.781
13	5.0	3.3	1.8	-ADJ	16.2	86.6	0.844
14	5.0	3.3	1.8	ADJ	9.53	93.1	0.906
15	5.0	3.0	1.8	ADJ	Short	Open	1.000

The inverting inputs on the V3 and/or V4 comparators are set to 0.5V when the positive adjustable modes are selected and with T0 and T1 low (5% tolerance) (Figure 5). The tap point on an external resistive divider, connected between the positive voltage being sensed and ground, is connected to the high impedance noninverting inputs (V3, V4). The trip voltage is calculated from:

$$V_{TRIP} = 0.5V \left(1 + \frac{R3}{R4}\right)$$

Once the resistor divider is set in the 5% tolerance mode, there is no need to change the divider for the other tolerance modes (7.5%, 10%, 12.5%) because the internal reference is scaled accordingly, moving the trip point in -2.5% increments.



# APPLICATIONS INFORMATION

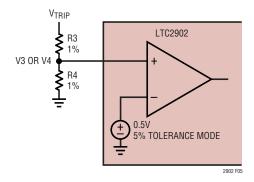


Figure 5. Setting the Positive Adjustable Trip Point

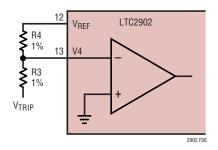


Figure 6. Setting the Negative Adjustable Trip Point

In the negative adjustable mode, the noninverting input on the V4 comparator is connected to ground (Figure 6). The tap point on an external resistive divider, connected between the negative voltage being sensed and the  $V_{REF}$  pin, is connected to the high impedance inverting input (V4).  $V_{REF}$  provides the necessary level shift required to operate at ground. The trip voltage is calculated from:

$$V_{TRIP} = -V_{REF} \left(\frac{R3}{R4}\right); V_{REF} = 1.210V$$

T0,T1 Low (5% Tolerance Mode)

Once the resistor divider is set in the 5% tolerance mode, there is no need to change the divider for the other tolerance modes (7.5%, 10%, 12.5%) because  $V_{REF}$  is scaled accordingly, moving the trip point in -2.5% increments.

In a negative adjustable application, the minimum value for R4 is limited by the sourcing capability of  $V_{REF}$  ( $\pm 1$ mA). With no other load on  $V_{REF}$ , R4 (minimum) is:

$$1.21V \div 1mA = 1.21k\Omega$$

Tables 2 and 3 offer suggested 1% resistor values for various adjustable applications.

Table 2. Suggested 1% Resistor Values for the ADJ Inputs

V <sub>SUPPLY</sub> (V)	V <sub>TRIP</sub> (V)	<b>R3</b> ( <b>k</b> Ω)	R4 (kΩ)
12	11.25	2150	100
10	9.4	1780	100
8	7.5	1400	100
7.5	7	1300	100
6	5.6	1020	100
5	4.725	845	100
3.3	3.055	511	100
3	2.82	464	100
2.5	2.325	365	100
1.8	1.685	237	100
1.5	1.410	182	100
1.2	1.120	124	100
1	0.933	86.6	100
0.9	0.840	68.1	100

Table 3. Suggested 1% Resistor Values for the -ADJ Input

V <sub>SUPPLY</sub> (V)	V <sub>TRIP</sub> (V)	R3 (kΩ)	R4 (kΩ)		
-2	-1.87	187	121		
-5	-4.64	464	121		
-5.2	-4.87	487	121		
-10	-9.31	931	121		
-12	-11.30	1130	121		

Although all four supply monitor comparators have built-in glitch immunity, bypass capacitors on V1 and V2 are recommended because the greater of V1 or V2 is also the  $V_{CC}$  for the chip. Filter capacitors on the V3 and V4 inputs are allowed.

#### Power-Down

On power-down, once any of the  $V_X$  inputs drop below their threshold, RST and COMPX are held at a logic low. A logic low of 0.4V is guaranteed until both V1 and V2 drop below 1V. If the bandgap reference becomes invalid ( $V_{CC} < 2V$  typ), the part will reprogram once  $V_{CC}$  rises above 2.4V (max).

#### **Monitor Output Rise and Fall Time Estimation**

All of the outputs (RST, COMPX) have strong pull-down capability. If the external load capacitance  $(C_{LOAD})$  for a



# APPLICATIONS INFORMATION

particular output is known, output fall time (10% to 90%) is estimated using:

$$t_{FALL} \approx 2.2 \bullet R_{PD} \bullet C_{LOAD}$$

where  $R_{PD}$  is the on-resistance of the internal pull-down transistor. The typical performance curve (V<sub>OL</sub> vs I<sub>SINK</sub>) demonstrates that the pull-down current is somewhat linear versus output voltage. Using the 25°C curve,  $R_{PD}$  is estimated to be approximately  $40\Omega.$  Assuming a 150pF load capacitance, the fall time is about 13.2ns.

Although the outputs are considered to be "open-drain," they do have a weak pull-up capability (see COMPX or RST Pull-Up Current vs V2 curve). Output rise time (10% to 90%) is estimated using:

$$t_{RISE} \approx 2.2 \bullet R_{PU} \bullet C_{LOAD}$$

where  $R_{PU}$  is the on-resistance of the pull-up transistor. The on-resistance as a function of the V2 voltage at room temperature is estimated using:

$$R_{PU} = \frac{6 \cdot 10^5}{V2 - 1} \Omega$$

with V2 = 3.3V,  $R_{PU}$  is about 260k. Using 150pF for load capacitance, the rise time is 86 $\mu$ s. If the output needs to pull up faster and/or to a higher voltage, a smaller external pull-up resistor may be used. Using a 10k pull-up resistor, the rise time is reduced to 3.3 $\mu$ s for a 150pF load capacitance.

The LTC2902-2 has an active pull-up to V2 on the  $\overline{RST}$  output. The typical performance curve ( $\overline{RST}$  Pull-Up Current vs V2 curve) demonstrates that the pull-up current is somewhat linear versus the V2 voltage and R<sub>PU</sub> is estimated to be approximately 625 $\Omega$ . A 150pF load capacitance makes the rise time about 206ns.

#### **Selecting the Reset Timing Capacitor**

The reset time-out period is adjustable in order to accommodate a variety of microprocessor applications. The reset time-out period,  $t_{RST}$ , is adjusted by connecting a capacitor,  $C_{RT}$ , between the CRT pin and ground. The value of this capacitor is determined by:

$$C_{RT} = t_{RST} \cdot 217 \cdot 10^{-9}$$

with  $C_{RT}$  in Farads and  $t_{RST}$  in seconds. The  $C_{RT}$  value per millisecond of delay can also be expressed as  $C_{RT}/ms = 217$  (pF/ms).

Leaving the CRT pin unconnected will generate a minimum reset time-out of approximately  $50\mu s$ . Maximum reset time-out is limited by the largest available low leakage capacitor. The accuracy of the time-out period will be affected by capacitor leakage (the nominal charging current is  $2\mu A$ ) and capacitor tolerance. A low leakage ceramic capacitor is recommended.

#### Tolerance Programming and the RESET Disable

Using the two digital inputs T0 and T1, the user can program the global supply tolerance for the LTC2902 (5%, 7.5%, 10%, 12.5%). The larger tolerances provide more headroom by lowering the trip thresholds.

**Table 4. Tolerance Programming** 

T0	T1	TOLERANCE (%)	V <sub>REF</sub> (V)
Low	Low	5	1.210
Low	High	7.5	1.178
High	Low	10	1.146
High	High	12.5	1.113

Under conventional operation, RST and COMPX will go low when  $V_X$  is below its threshold. At any time, the  $\overline{RDIS}$  pin can be pulled low, overriding the reset operation and forcing the  $\overline{RST}$  pin high. This feature is useful when determining supply margins under processor control since the reset command will not be invoked. The RDIS pin is connected to a weak internal pull-up to  $V_{CC}$  (10µA typ), allowing the pin to be left floating if unused.

# Ensuring RST Valid for V<sub>CC</sub> Down to 0V (LTC2902-2)

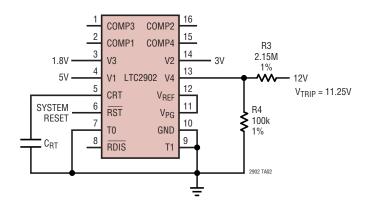
When V<sub>CC</sub> is below 1V the RST pull-down capability is drastically reduced. The RST pin may float to undetermined voltages when connected to high impedance (such as CMOS logic inputs). The addition of a pull-down resistor from RST to ground will provide a path for stray charge and/or leakage currents. The resistor value should be small enough to provide effective pull-down without excessively loading the pull-up circuitry. Too large a value may not pull down well enough. A 100k resistor from RST to ground is satisfactory for most applications.

2902

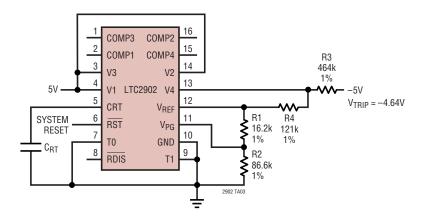


# TYPICAL APPLICATIONS

#### Quad Supply Monitor, 5% Tolerance 5V, 3V, 1.8V, 12V (ADJ)

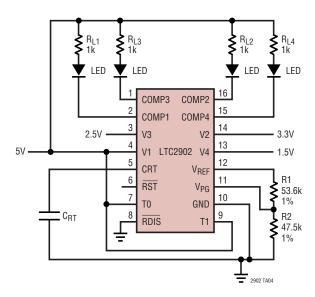


# 5V, -5V Monitor with Unused V2, V3 Inputs Pulled Above Trip Thresholds (5% Tolerance)



# TYPICAL APPLICATIONS

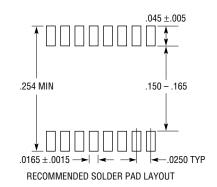
Quad Supply Monitor with LED Undervoltage Indicators, 12.5% Tolerance, Reset Disabled 5V, 3.3V, 2.5V, 1.5V

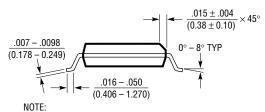


# PACKAGE DESCRIPTION

#### GN Package 16-Lead Plastic SSOP (Narrow .150 Inch)

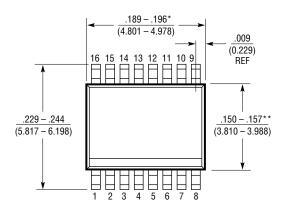
(Reference LTC DWG # 05-08-1641)

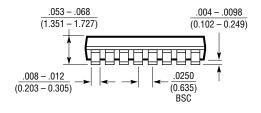




1. CONTROLLING DIMENSION: INCHES

- 2. DIMENSIONS ARE IN  $\frac{\text{INCHES}}{(\text{MILLIMETERS})}$
- 3. DRAWING NOT TO SCALE
- \*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE
- \*\*DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE



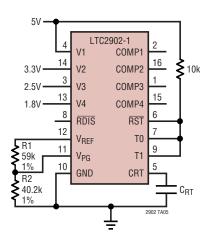


GN16 (SSOP) 0502



# TYPICAL APPLICATION

Quad Supply Monitor with Hysteresis 5% Tolerance (Supp<u>lies</u> Rising) 12.5% Tolerance (After RST Goes High)



# **RELATED PARTS**

PART NUMBER	DESCRIPTION	COMMENTS
LTC690	5V Supply Monitor, Watchdog Timer and Battery Backup	4.65V Threshold
LTC694-3.3	3.3V Supply Monitor, Watchdog Timer and Battery Backup	2.9V Threshold
LTC699	5V Supply Monitor and Watchdog Timer	4.65V Threshold
LTC1232	5V Supply Monitor, Watchdog Timer and Push-Button Reset	4.37V/4.62V Threshold
LTC1326	Micropower Precision Triple Supply Monitor for 5V, 3.3V and ADJ	4.725V, 3.118V, 1V Thresholds (±0.75%)
LTC1326-2.5	Micropower Precision Triple Supply Monitor for 2.5V, 3.3V and ADJ	2.363V, 3.118V, 1V Thresholds (±0.75%)
LTC1536	Precision Triple Supply Monitor for PCI Applications	Meets PCI t <sub>FAIL</sub> Timing Specifications
LTC1726-2.5	Micropower Triple Supply Monitor for 2.5V, 3.3V and ADJ	Adjustable RESET and Watchdog Time-Outs
LTC1726-5	Micropower Triple Supply Monitor for 5V, 3.3V and ADJ	Adjustable RESET and Watchdog Time-Outs
LTC1727-2.5/LTC1727-5	Micropower Triple Supply Monitor with Open-Drain Reset	Individual Monitor Outputs in MSOP
LTC1728-1.8/LTC1728-3.3	Micropower Triple Supply Monitor with Open-Drain Reset	5-Lead SOT-23 Package
LTC1728-2.5/LTC1728-5	Micropower Triple Supply Monitor with Open-Drain Reset	5-Lead SOT-23 Package
LTC1985-1.8	Micropower Triple Supply Monitor with Push-Pull Reset Output	5-Lead SOT-23 Package
LTC2900	Programmable Quad Supply Monitor	Adjustable RESET, 10-Lead MSOP Package
LTC2901	Programmable Quad Supply Monitor	Adjustable RESET and Watchdog Timer, 16-Lead SSOP Package